502332857 05/02/2013

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Satoru AMOU	02/04/2013
Tomiya ABE	02/14/2013
Daisuke SHANAI	02/14/2013
Hiroaki KOMATSU	02/15/2013
Kenichi MURAKAMI	02/18/2013

RECEIVING PARTY DATA

Name:	Hitachi Cable, Ltd.	
Street Address:	14-1, Sotokanda 4-chome	
City:	Chiyoda-ku, Tokyo	
State/Country:	JAPAN	

Name:	Hitachi Cable Fine-Tech, Ltd.	
Street Address:	10-1, Kawajiri-cho 4-chome	
City:	Hitachi-shi, Ibaraki	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13770225	

CORRESPONDENCE DATA

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PATENT

REEL: 030335 FRAME: 0621

DP \$40.00 13770225

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ATTORNEY DOCKET NUMBER:	107844.65335US
NAME OF SUBMITTER:	Michael H. Jacobs
Signature:	/Michael H. Jacobs/
Date:	05/02/2013
Total Attachments: 1 source=65335US_ASSIGNMENT_001#page1.tif	

PATENT REEL: 030335 FRAME: 0622

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to the below named inventor(s), citizens of Japan by Hitachi Cable, Ltd., and Hitachi Cable Fine-Tech, Ltd., corporations organized under the laws of Japan, located at 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo, Japan, and 10-1, Kawajiri-cho 4-chome, Hitachi-shi, Ibaraki, Japan, respectively, receipt of which is hereby acknowledged, we, the below named inventor(s), do hereby sell and assign to said Hitachi Cable, Ltd., and Hitachi Cable Fine-Tech, Ltd., their successors and assigns, all our right, title and interest, in and for the United States of America, in and to

THERMOSETTING ADHESIVE COMPOSITION, AND HEAT RESISTANT ADHESIVE FILM AND WIRING FILM USING THE SAME

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi Cable, Ltd., and Hitachi Cable Fine-Tech, Ltd., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Cable, Ltd., and Hitachi Cable Fine-Tech, Ltd.,

Signed on the date(s) indicated aside signatures:

	(発明者フルネームサイン)	(署名日)	
1)	Satoru AMOU Latoru amau	2/4/2013	
2)	Tomiya ABE Tomiya all	2/14/2013	
3)	Daisuke SHANAI Dairuka Shanai	2/14/2013	
4)	HIROAKI KOMATSU SKRADON SLONETON	2/15/2013	
5)	Kenichi MURAKAMI Henichi mwakami	2/18/2013	
6)			
7)			
8)			
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